

#### Integrated 15W wireless charging transmitter SOC which support PD input

#### **Features**

- Compliant with the WPC v1.33 specificatiosn transmitter design
- Support 5~15W applications
  - ♦ Single 5W applications
  - Fast charge input for 5~15W applications
    5V input for 5W output application
    9V input for 5W, 7.5W, 10W output application
  - Support multi-coil scheme(two coils, three coils)
- Integrate NMOS full bridge driver and full bridge power MOS
- Integrate voltage/current demodulator
- Support FOD (Foreign Object Detection) function
  - ♦ High sensitivity
  - ♦ Support dynamic FOD
  - ♦ External resistor adjusts FOD parameters
- Low quiescent dissipation and high efficiency
  - ♦ 10mA quiescent current
  - $\diamond$  Charging efficiency is up to 80
- Compatible with NPO and CBB capacitors
- Support Dynamic Power Modulation (DPM) for insufficient USB power source
  - ♦ Support low voltage charger of 5V/500mA
- Input over voltage, over current, under voltage protection
- Support firmware upgrade repeatedly
- Support PD3.0 input request
- Support DPDM Fast Charge input request
- Support Qi protocol BPP, PPDE certification
- Support NTC over temperature protection
- Support up to 3 LEDs indication
- Pacage: 5 mm × 5 mm 0.5pitch QFN32

#### Description

IP6829 is a wireless power transmitter controller SoC that integrates all required functions for the latest WPC Qi V1.3 specifications compliant wireless power transmitter design. Support A11, A11a, MP-A2 coil, support 5W, Apple 7.5W, Samsung 10W, 15W charging. It used analog PING to detect a RX wireless device for charging . Once RX device is detected, the IP6829 establish a communication with the RX wireless device and controls the coil power transfer by adjusting operation frequency, depended on calculating the data packages, received from RX device, with PID algorithm. IP6829 terminate power transfer when RX device is fully charged.

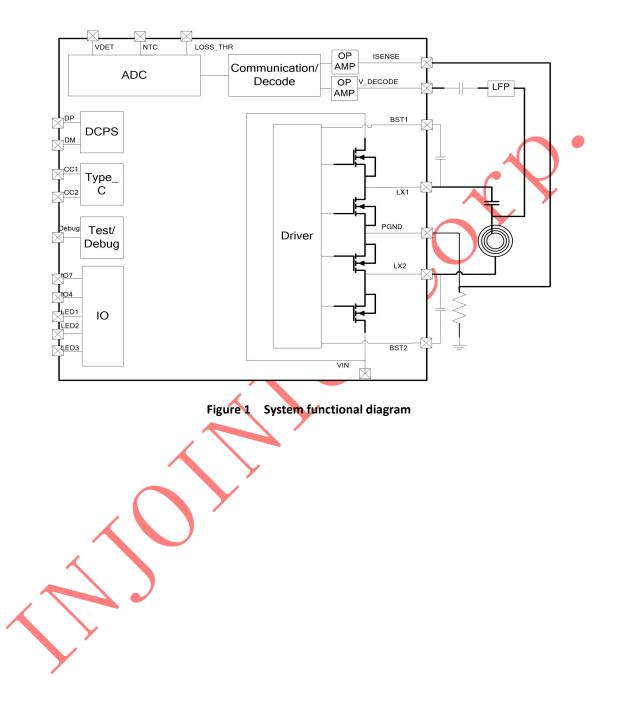
IP6829 integrate full-bridge driver and full bridge power MOS, includes voltage and current two-way ASK demodulation module. IP6829 is a highly integrated SoC for small-size and low bom cost solutions and reduced time-to-market.

#### **Applications**

- Charge Jacket, wireless charging base
- Car wireless charging device



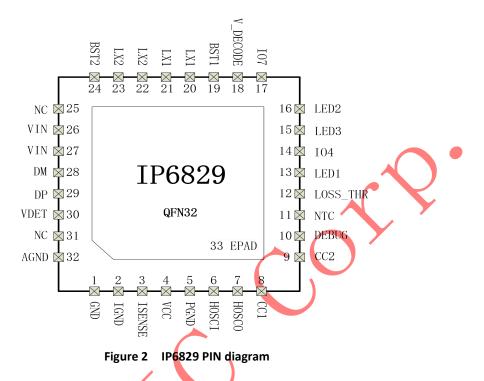
# **System Functional Diagram**







## 1. Pin Description



Pin No.	Pin Name	Description
1	GND	Analog Ground
2	IGND	Current communication/demodulation negative input
3	ISENSE	Current communication/demodulation positive input
4	VCC	Internal VCC supply, powered from VIN to 100R resistor or 4V LDO
5	PGND	The power ground of the internal power MOS transistor is connected to the external 20 $m\Omega$ sampling resistor positive terminal
6	HOSCI	External crystal oscillator input
7	HOSCO	External crystal oscillator output
8	CC1	Type_C detection pin CC1
9	CC2	Type_C detection pin CC2
10	DEBUG	Debug pin, serial output print information
11	NTC	NTC input PIN
12	LOSS_THR	Dynamic FOD parameter adjustment/PCB NTC input PIN
13	LED1	LED1 output
14	104	Internal GPIO4
15	LED3	LED3 output
16	LED2	LED2 output



17	107	Internal GPIO7
18	V_DECODE	Voltage communication/demodulation input
19	BST1	Internal high voltage drive, connect to capacitor to LX1
20	LX1	H-bridge switching node 1
21	LX1	H-bridge switching node 1
22	LX2	H-bridge switching node 2
23	LX2	H-bridge switching node 2
24	BST2	Internal high voltage drive, connect to capacitor to LX2
25	NC	NC PIN is left floating and cannot be grounded
26	VIN	External voltage input PIN
27	VIN	External voltage input PIN
28	DM	USB DM
29	DP	USB DP
30	VDET	Coil voltage sense input
31	NC	NC PIN is left floating and cannot be grounded
32	AGND	Analog Ground
33	EPAD (PGND)	The power ground of the internal power MOS transistor is connected to the external 20 m $\Omega$ sampling resistor positive terminal

## 2. Absolute Maximum Ratings

Parameters	Symbol	Min	Max	Unit
	VIN	-0.3	16	
Input Voltage Range	VCC	-0.3	12	v
	DP,DM	-0.3	8	
Junction Temperature Range	TJ	-40	125	Ĉ
Storage Temperature Range	Tstg	-60	125	Ĉ
Package Thermal Resistance	θ <sub>JA</sub>	4	0	°C <b>/w</b>
Human Body Model (HBM)	ESD	41	<٧	v

\*Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to Absolute Maximum Rated conditions for extended periods may affect device reliability.

## 3. Recommended Operating Conditions

Parameters	Symbol	Min	Тур	Max	Unit
VIN input Voltage Range	VIN	4.5	5/9	12	V
I/O Voltage Range	LED1,LED2,LED3	GND-0.3		VCC+0.3	V



# IP6829

NTC,LOSS_THR	GND-0.3	VCC+0.3	
104,107	GND-0.3	VCC+0.3	
DP, DM,CC1,CC2	GND-0.3	5.5	

\*Devices' performance cannot be guaranteed when working beyond those Recommended Operating Conditions.

## 4. Electrical Characteristics

Unless otherw	ise specified, TA =25 $^\circ\!\!\mathbb{C}$					
Parameters	Symbol	Min	Тур	Max	Unit	Test Condition
VIN		4.5	5/9	12	V	
VCC		3.8	4.2	5	V	Y
VIH	Input high level	0.7xVCC			V	
VIL	Input low level			0.3xVCC	v	
VOH	Input high level		vcc		V	
VOL	Input low level		GND		V	
Source current	LED1, LED2, LED3 output current capability		2	4	mA	Source current to output high level is 0.8xVCC
Rds	Drive bridge MOS tube impedance		25		mΩ	

## 5. Function Description

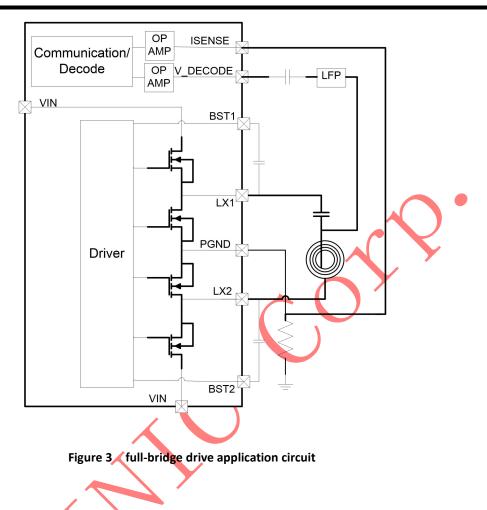
#### PD fast charge input request

The built-in PD protocol input request module can apply for fast charging voltage to the PD adapter through CC1 and CC2.

#### Full-bridge and Power MOS

IP6829 includes two symmetry half-bridge drive module with built-in power MOS.





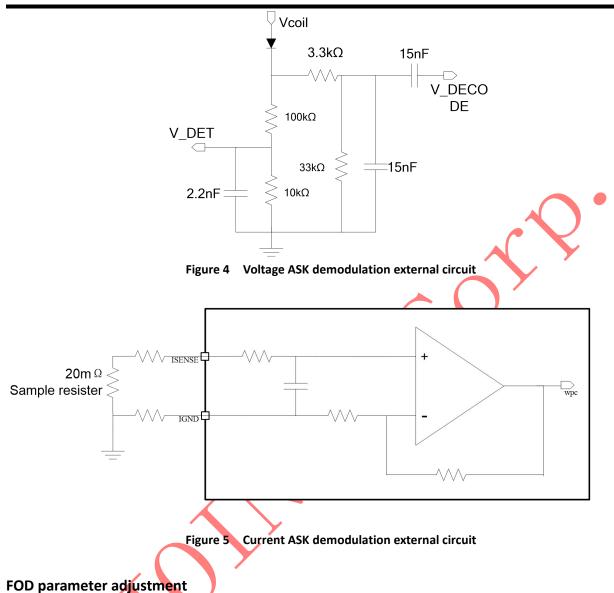
#### DPM

IP6829 support Dynamic Power Management function for USB power source with insufficient power supply ability, which can guarantee the charging status will not break off or suspend. When the system detect the input voltage is lower than 4.3V, DPM function will be enabled and the transmitting power will be reduced. When the input voltage returns to above 4.75V and the input current is reduced by 200mA compared to when entering DPM, the system exits the DPM state.

#### **Digital Demodulation**

Integrate two-way ASK demodulation module, sampling the voltage and current of the coil separately. Current demodulation, additional separate devices are needed for low pass filters and first amplifier, signals is send to IC for digital demodulation and decode after DC blocked.

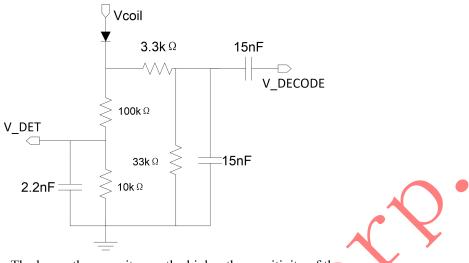




IP6829 supports static FOD foreign object detection and dynamic FOD foreign object detection; Static FOD means that foreign objects on the coil can be detected without wireless charging; Dynamic FOD means that foreign objects on the coil can be detected while charging wirelessly;

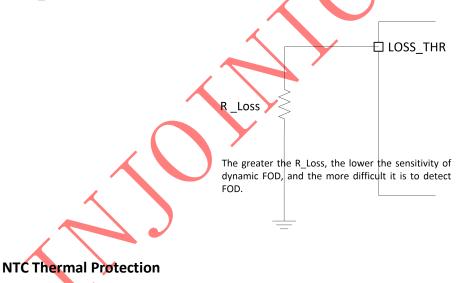
The IP6829 can adjust the sensitivity of the static FOD by adjusting the capacitance on the V\_DET pin; the default is to connect the 2.2nF capacitor to ground, standard static FOD sensitivity: the greater the capacitance, the higher the sensitivity of static FOD, and the easier to detect foreign bodies.





The larger the capacitance, the higher the sensitivity of the static FOD, and the easier it is to detect foreign bodies.

IP6829 can adjust the sensitivity of dynamic FOD by external resistor to GND on the LOSS\_THR pin; The LOSS\_THR pin defaults to a 100K resistor to ground, using standard dynamic FOD sensitivity; The larger the external resistor R\_Loss of LOSS\_THR, the lower the sensitivity of dynamic FOD, the less easy to detect FOD; The sensitivity of the dynamic FOD is set only by detecting the resistance of the LOSS\_THR pin at power-on; 50K<R\_LOSS resistor <130K.

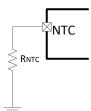


The NTC pin of the IP6829 is fixed to output 20uA current, and the NTC PIN determines the NTC temperature by sampling the voltage of the NTC pin. The NTC thermal shutdown protection is for enhancement application, but not limited to thermal shutdown. When NTC voltage is lower than 0.48V, the system will terminate the power transmittion. After entering NTC protection, the NTC voltage is greater than 0.70V, and normal charging resumes. If NTC is not used, this pin is grounded through a 100K resistor.

NTC resistor selection, refer to the following stage:

- 1. Refer to NTC resistor data handbook, search the resistor-temperature relation sheet
- 2. Find the related resistor R\_NTC according to the protection temperature





Recommended parameters of thermal resistor: RNTC=100K@25 degrees Celsius B=3950;

#### **LED Status Indicator**

IP6829 can drive 2 LEDs directly through serial current-limit resistor. LEDs' status and system status relations are listed below:

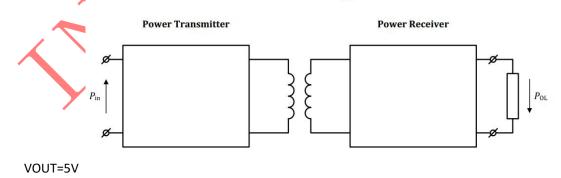
Status	LED1			LED2	
Power-on	Flashing three times simultaneousl				neously
Standby	Off			Off	
Charging	On			Off	
Abnormal	Off			Flashing	
Charge complete	Off			On	

Firmware can be modified by customization or configuration tools to support up to three LEDs, Support breathing, flashing, always bright, always dark, pwm to adjust the brightness.

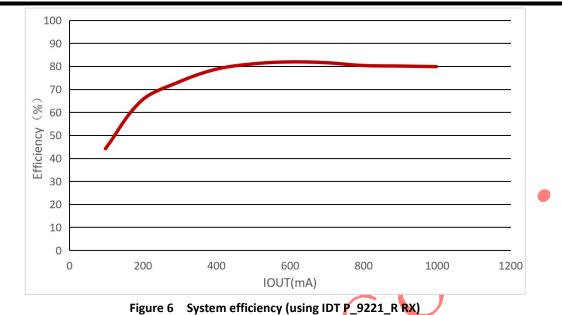
#### **Test Waveform**

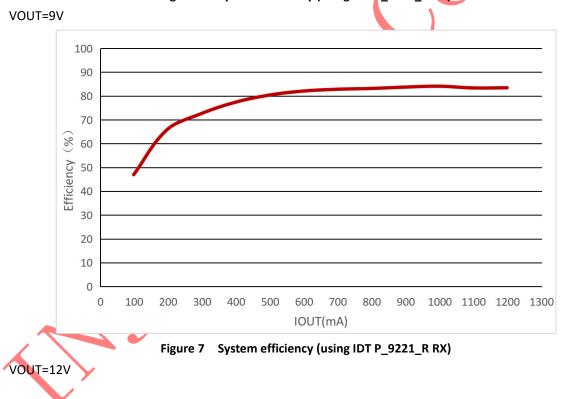
Using IDT P9221\_R solution for RX device, the relationship of efficiency and system output power and test method are outlined below.

$$\eta_{\text{system}} = \frac{P_{\text{OL}}}{P_{\text{in}}}$$











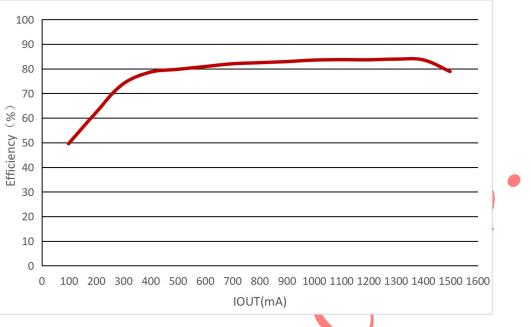


Figure 8 System efficiency (using IDT P\_9221\_R RX)

## 6. Operating Instructions

IP6829 realizes wireless charging schemes of different powers according to the matching of different transmitting coils and resonant capacitors.

According to customer needs, 10uH coil with 250nF resonant capacitor, and 6.3uH coil with 400nF resonant capacitor.

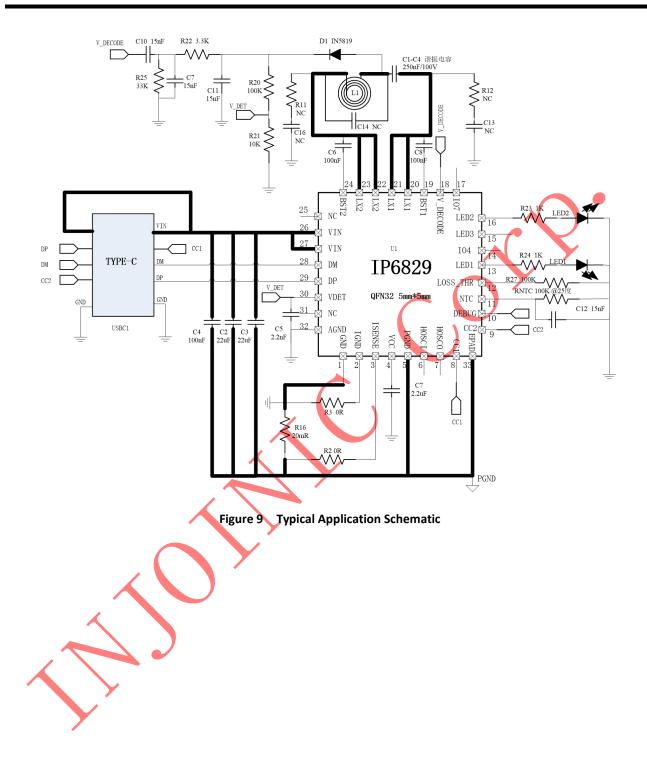
## 7. Firmware Upgrade Instructions

IP6829 can be repeatedly burned firmware, you need to use the supporting upgrade tools to upgrade.

## 8. Typical Application Schematic

IP6829 wireless charging solution only needs capacitors, resistors and few passive devices. BST1, BST2 boost capacitors C6, C8 can't be omitted.







## **BOM List**

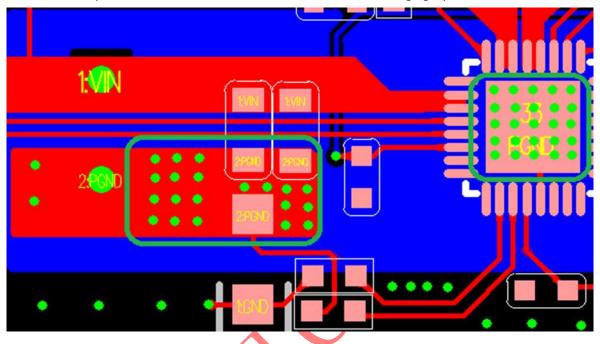
Item	Part Name	Description&specification	Description	Qty
1	LED	LED2,LED1	LED0805	2
2	IN5819	D1	SOD-523_L1.2-W0.8-LS1.6-RD	1
3	250nF	C1-C4	CAP-TH_L13.0-W7.5-P10.00-D1.0	1
4	15nF	C10,C11,C12	C0603	3
5	2.2nF	C5	C0603	1
6	100nF	C4,C6,C8	C0603	3
7	2.2uF	C7	C0603	1
8	IP6829	U1	QFN-32_L5.0-W5.0-P0.50-BL-EP3.4	1
9	<b>100k</b> Ω	RNTC	R0603	1
10	10uH	L1	IND-SMD_L2.5-W2.0	1
11	33k	R25	R0603	1
12	3.3k	R22	R0603	1
13	100k	R20,R27	R0603	2
14	1k	R24,R23	R0603	2
15	10k	R21	R0603	1
16	10uF	C1	C0805	1
17	22uF	C2,C3	C0805	2
18	20mR	R16	R0603	1
19	TYPE-C-31-M-12	USBC1	USB-C_SMD-TYPE-C-31-M-12	1

Email: service@injoinic.com

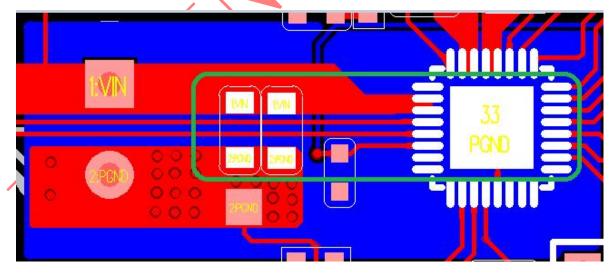


## 9. Layout Notifications

1. As shown in the following figure: current sampling resistance and IP6829's PGND are power lines, which need to be as short as possible, and more holes need to be added when changing layers;



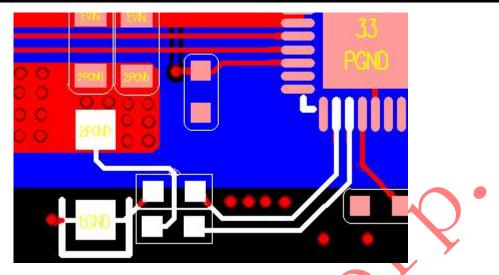
2. As shown in the following figure: input the filter capacitance between VIN and PGND, the smaller the ring road area, the better;



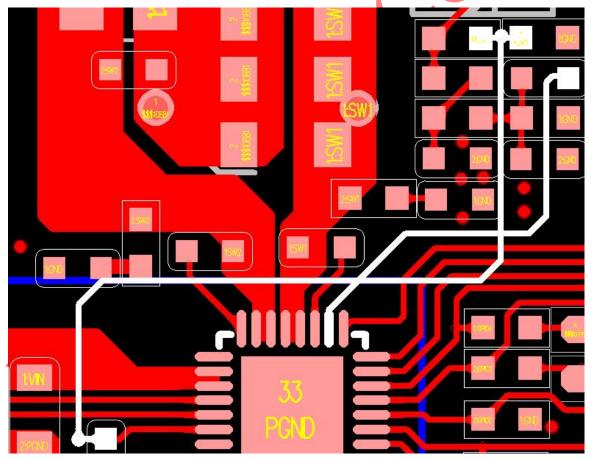
- 3. The capacitor of the 4th VCC shall have a sufficient capacity of 2.2UF and shall be located close to the Chip Pin; and the Ground Circuit from the 4th VCC capacitor to the 1st Chip Pin shall not be cut off by other signals.
- 4. As shown in the following figure: Sampling routes from current sampling resistors to IP6829 ISENSE and IGND need separate leads from both ends of resistors, not to coincide with the power routes of the same networkand to be as short as possible, while away from resonant capacitors and coils.







5. As shown in the following figure: The V\_DECODE and V\_DET routes of IP6829 are as far away as possible from resonant capacitors, coils and other power routes, and need to be surrounded by ground.

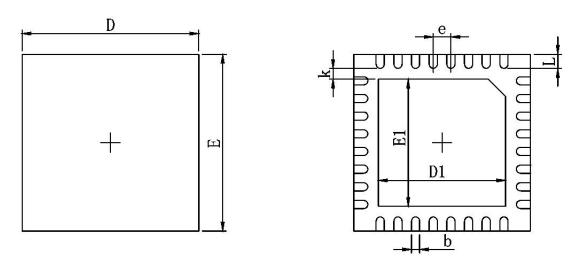


6. The loop area between the resonant capacitor and the coil and the IP6829 needs to be as small as possible, and away from the low-voltage signal lines such as LED, NTC, and IO.



IP6829

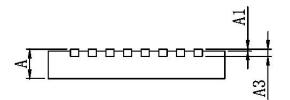
## 10.Package



BOTTOM

VIEW

TOP VIEW



SIDE	VIEW
SIDE	A T C M

	Dimonsione	n Millimeters	Dimonsion	e In Inchoe	
Symbol	-		Dimensions In Inches		
e jiille et	Min.	Max.	Min.	Max.	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.203	REF.	0.008	REF.	
D	4.924	5.076	0.194	0.200	
Е	4.924	5.076	0.194	0.200	
D1	3.300	3.500	0.130	0.138	
E1	3.300	3.500	0.130	0.138	
k	0.200	0.200MIN.		BMIN.	
b 0.200		0.300	0.008	0.012	
е	0.500	TYP.	0.020	TYP.	
L	0.324	0.476	0.013	0.019	



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